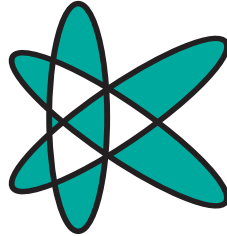


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OKURA HOLDINGS LIMITED

(Incorporated in Hong Kong with limited liability)

(Stock code: 01655)

DISCLOSABLE TRANSACTION SUBSCRIPTION OF BONDS

The Board is pleased to announce that the Company and Sinwa entered into the Bond Agreements on 26 July 2018, pursuant to which the Company has agreed to subscribe for two series of Bonds at face value to be issued by Sinwa, in an aggregate amount of JYP1,000 million.

As one or more of the applicable percentage ratios in respect of the Bond Agreements exceed 5% but are all below 25%, the entering into of the Bond Agreements constitute disclosable transaction of the Company under Chapter 14 of the Listing Rules.

INTRODUCTION

The Board is pleased to announce that the Company and Sinwa entered into the Bond Agreements on 26 July 2018, pursuant to which the Company has agreed to subscribe for two series of Bonds at face value to be issued by Sinwa in an aggregate amount of JYP1,000 million.

THE BOND AGREEMENTS

The principal terms of the Bond Agreements are summarized as follows:

Date	26 July 2018
Parties	(i) The Company, as subscriber; and (ii) Sinwa, as issuer

Bond type JPY denominated, unsecured and unlisted bonds transferrable only with the consent of the directors of Sinwa.

Payment method The Company shall pay the subscription amounts by bank transfer to a bank account designated by Sinwa on 26 July 2018.

(a) 1st Series

1. Principal amount and face value: JPY500,000,000
2. Interest rate: 3.00% per annum, payable bi-annually
3. Expected date of issue: 27 July 2018
4. Maturity/redemption date: 31 July 2021 with no early redemption option

(b) 2nd Series

1. Principal amount and face value: JPY500,000,000
2. Interest rate: 3.00% per annum, payable at redemption
3. Expected date of issue: 27 July 2018
4. Maturity/redemption date: 31 January 2019 with no early redemption option

The Bonds shall be issued to the Company at face value. The terms of the Bond Agreements were determined by the parties after arm's length negotiations and are on normal commercial terms.

REASONS FOR THE SUBSCRIPTION OF THE BONDS

The Company expects to satisfy the subscription amounts by internal resources comprising primarily surplus cash from operations currently held in the form of USD time deposits. Taking into account the appreciation of U.S. dollars against Japanese Yen, the Directors considered that it is beneficial for the Group to reinvest such surplus cash into JPY denominated bonds that allow the Group to capture foreign

exchange gains and to earn a higher yield. The Directors also considered that the terms of the Bond Agreements are fair and reasonable and are in the interests of the Company and its shareholders as a whole.

LISTING RULES IMPLICATIONS

As one or more of the applicable percentage ratios in respect of the Bond Agreements exceed 5% but are all below 25%, the entering into of the Bond Agreements constitute disclosable transaction of the Company under Chapter 14 of the Listing Rules.

INFORMATION ON SINWA

Sinwa is a company incorporated under the laws of Japan and headquartered in Fukuoka, Japan, engaging in the business of commercial and consumer finance. To the best of the Directors' knowledge, information and belief, and having made all reasonable enquiries, Sinwa and its ultimate beneficial owner(s) are third parties independent of the Company and its connected persons.

INFORMATION ON THE GROUP

The Group is principally engaged in the business of operating pachinko halls in Japan. The Group is currently operating 17 pachinko halls in the Kyushu, Kanto, Kansai and Chugoku regions in Japan.

DEFINITIONS

In this announcement, the following expressions shall have the following meaning:

“Board”	the board of Directors
“Bonds”	the two series of Bonds to be issued by Sinwa at face value to the Company on terms as disclosed in this announcement
“Bond Agreements”	the two agreements, both dated 26 July, entered into by the issuer and the Company in respect of the subscription of the Bonds
“Company”	Okura Holdings Limited (Stock Code: 01655)
“connected persons”	has the meaning ascribed to it under the Listing Rules

“Director(s)”	the director(s) of the Company
“Group”	the Company and its subsidiaries (as defined in the Listing Rules)
“Hong Kong”	the Hong Kong Special Administrative Region of the People’s Republic of China
“JPY”	Japanese Yen, the lawful currency of Japan
“Listing Rules”	the Rules Governing the Listing of Securities on The Stock Exchange of Hong Kong
“Sinwa”	Sinwa Co., Ltd.* (株式会社しんわ), the issuer of the Bonds
“Stock Exchange”	The Stock Exchange of Hong Kong Limited
“USD or U.S. dollars”	the lawful currency of the United States of America
“%”	per cent

For and on behalf of the Board
Okura Holdings Limited
Katsuya YAMAMOTO
Chief Executive Officer, Executive Director and
Chairman of the Board

Hong Kong, 26 July 2018

As at the date of this announcement, the Board comprises seven Directors, of which (i) four are executive Directors, namely Mr. Katsuya YAMAMOTO, Mr. Fumihide HAMADA, Mr. Yutaka KAGAWA and Mr. Toshiro OE; and (ii) three are independent non-executive Directors, namely Mr. Mitsuru ISHII, Mr. Yuji MATSUZAKI and Mr. Takamasa KAWASAKI.

* For identification purpose only